

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hye Jung KWON</td> <td>04/27/2012</td> </tr> <tr> <td>Hong June PARK</td> <td>04/27/2012</td> </tr> </tbody> </table>		Name	Execution Date	Hye Jung KWON	04/27/2012	Hong June PARK	04/27/2012
Name	Execution Date						
Hye Jung KWON	04/27/2012						
Hong June PARK	04/27/2012						
RECEIVING PARTY DATA							
Name:	POSTECH ACADEMY- INDUSTRY FOUNDATION						
Street Address:	San 31, Hyoja-dong, Nam-gu						
City:	Pohang-si, Gyeongsangbuk-do						
State/Country:	KOREA, REPUBLIC OF						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13536925</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13536925		
Property Type	Number						
Application Number:	13536925						
CORRESPONDENCE DATA							
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ATTORNEY DOCKET NUMBER:	GUA-0219-PT						
NAME OF SUBMITTER:	JAE Y. PARK						
Total Attachments: 2 source=Assmt_GUA0219#page1.tif source=Assmt_GUA0219#page2.tif							

CH \$40.00 13536925

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Insert Name(s) WHEREAS, KWON, Hye Jung of 102-220 SijiPrugioApt., Sawol-dong, Susung-gu, Daegu-si,
and Address(es) and PARK, Hong June of 9-1003 Gyo su Apt., Jigok-dong, Nam-gu, Pohang-si, Gyeongsangnam-do,
of Inventor(s) Korea.

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in

**Insert Title
of Invention**

Time difference amplifier and amplification method using slew rate control

which claims priority to [KOREA] Application No(s). 10-2012-0029860, filed on March 23, 2012,

for which the undersigned is (are) about to file an application for Letters Patent of the United States; and

**Insert Name
of Assignee**

WHEREAS, POSTECH ACADEMY - INDUSTRY FOUNDATION

**Insert Address
of Assignee**

of San 31, Hyoja-dong, Nam-gu, Pohang-si, Gyeongsangbuk-do, Korea

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and in any foreign countries.

NOW, THEREFORE, to all whom it may concern, be it known that, for good and valuable consideration paid to the undersigned, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto the Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Name of Inventor: KWON, Hye Jung, Signature kwon hye jung, Date 04.27.2012

Name of Inventor: PARK, Hong June, Signature Park Hong June, Date 04.27.2012